

STPS30U100DJF

ULVF™ power Schottky rectifier

Features

- High current capability
- Ultralow forward voltage drop
- Low thermal resistance
- High frequency operation
- High integration

Description

The STPS30U100DJF is a power Schottky rectifier featuring an ultralow forward voltage drop (ULVF), suited for high frequency switch mode power supply and DC to DC converters.

Packaged in PowerFLAT™, this device is intended to be used in notebook, game station and desktop adapters, providing these applications with good efficiency at both low and high load. Its low profile was especially designed to be used in applications with space-saving constraints.

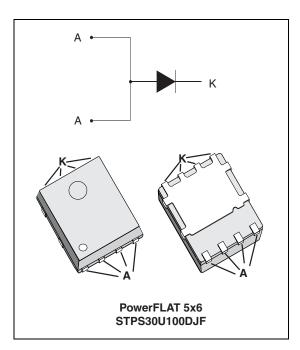


Table 1. Device summary

Symbol	Value		
I _{F(AV)}	30 A		
V _{RRM}	100 V		
T _j (max)	150 °C		
V _F (typ)	0.69 V		

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Characteristics STPS30U100DJF

1 **Characteristics**

Table 2. Absolute ratings (limiting values, anode terminals short circuited)

Symbol	Parameter	Value	Unit	
V_{RRM}	Repetitive peak reverse voltage		100	V
I _{F(RMS)}	Forward rms current		45	Α
I _{F(AV)}	Average forward current	$T_c = 75^{\circ}C, \ \delta = 0.5$	30	Α
I _{FSM}	Surge non repetitive forward current $t_p = 10 \text{ ms sine-wave}$		200	Α
T _{stg}	Storage temperature range	-65 to + 150	°C	
Tj	Maximum operating junction temperature (1)		150	°C

^{1.} $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	2.5	°C/W

Table 4. Static electrical characteristics (anode terminals short circuited)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
	I _R ⁽¹⁾ Reverse leakage current	T _j = 125 °C	V _R = 70 V		8	•	mA
I _R ⁽¹⁾		T _j = 25 °C	V - V	-	-	170	μΑ
	T _j = 125 °C	$V_R = V_{RRM}$	-	20	45	mA	
		T _j = 125 °C	I _F = 5 A	-	0.38	0.42	
V _F ⁽²⁾ Forward vo	Forward voltage drop	T _j = 125 °C	I _F = 10 A	-	0.475	0.53	V
	Torward voitage drop	T _j = 25 °C	I _F = 30 A	-	-	0.855	
		T _j = 125 °C		-	0.69	0.77	

^{1.} Pulse test: t_p = 5 ms, δ < 2%

To evaluate the maximum conduction losses use the following equation: P = 0.590 x $I_{F(AV)}$ + 0.006 x $I_{F}^{2}(RMS)$

$$P = 0.590 \times I_{F(AV)} + 0.006 \times I_{F^2(RMS)}$$

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^{2.} Pulse test: $t_p = 380 \mu s$, $\delta < 2\%$

STPS30U100DJF Characteristics

Figure 1. Average forward power dissipation Figure 2. Average forward current versus average forward current ambient temperature (δ = 0.5) (maximum values)

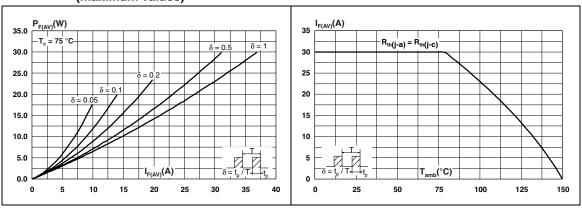


Figure 3. Non repetitive surge peak forward current versus overload duration (maximum values)

Figure 4. Relative variation of thermal impedance, junction to case, versus pulse duration

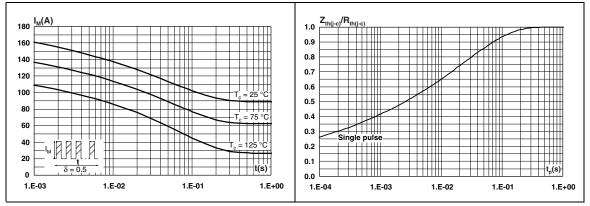
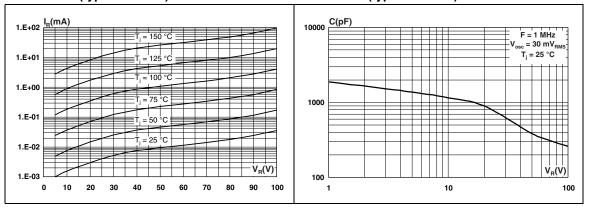


Figure 5. Reverse leakage current versus reverse voltage applied (typical values)

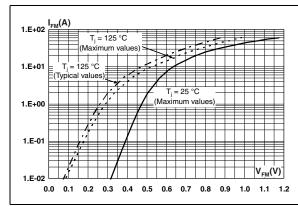
Figure 6. Junction capacitance versus reverse voltage applied (typical values)

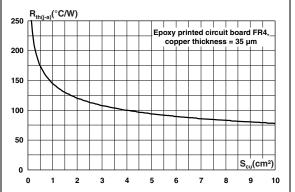


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Figure 7. Forward voltage drop versus forward current

Figure 8. Thermal resistance, junction to ambient, versus copper surface under tab



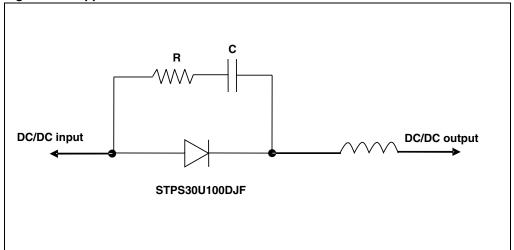


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2 Application information

It is mandatory to ensure a peak reverse voltage below the V_{RRM} absolute rating. Therefore ST recommends the use of an RC clamping snubber circuit in parallel with the STPS30U100DJF device.

Figure 9. Application schematic

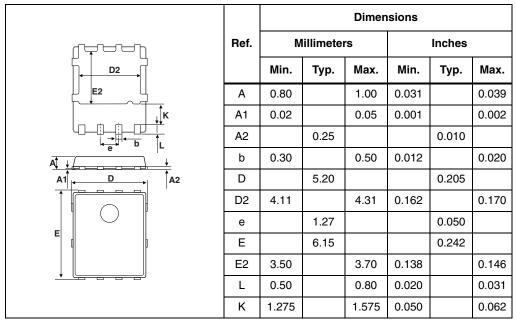


3 Package information

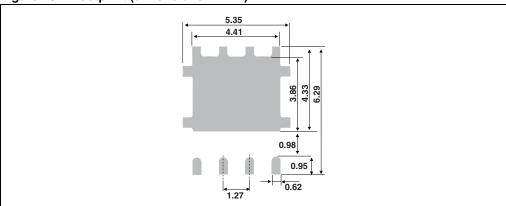
- Epoxy meets UL94,V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 5. PowerFLAT 5x6 dimensions







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STPS30U100DJF Ordering information

Dot identifying Pin A1 location

4.0

0.30

0.20

0.1.55

R 0.50

All dimensions are typical values in mm

User direction of unreeling

Figure 11. Tape and reel specifications

4 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS30U100DJF-TR	PS30 U100	PowerFLAT 5x6	95 mg	3000	Tape and reel

5 Revision history

Table 7. Document revision history

Date	Revision	Changes
02-Nov-2010	1	First issue.
09-Dec-2010	2	Added "maximum" to conduction loss calculation in Section 1 on page 2.
20-May-2011	3	Added reference E in <i>Table 5</i> . Updated package graphics. Updated base quantity and marking in <i>Table 6</i> . Added <i>Figure 11</i> .

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